

UNISONIC TECHNOLOGIES CO., LTD

10N70Z Power MOSFET

10A, 700V N-CHANNEL POWER MOSFET

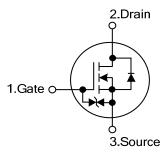
■ DESCRIPTION

The **UTC 10N70Z** is a high voltage and high current power MOSFET, designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.

■ FEATURES

- * $R_{DS(ON)}$ =1.2 Ω @ V_{GS} =10V
- * Low gate charge (typical 44 nC)
- * Low Crss (typical 18 pF)
- * Fast switching
- * 100% avalanche tested
- * Improved dv/dt capability

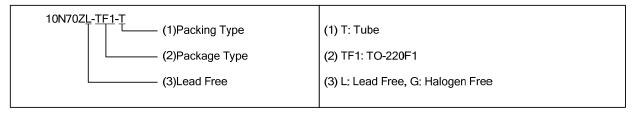
■ SYMBOL

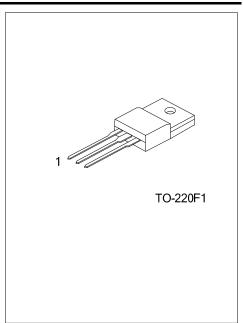


ORDERING INFORMATION

Ordering Number		Dookogo	Pin /	Assignr	Dooking		
Lead Free	Halogen Free	- Package	1	2	3	Packing	
10N70ZL-TF1-T	10N70ZG-TF1-T	TO-220F1	G	D	S	Tube	

Note: Pin Assignment: G: Gate D: Drain S: Source





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■ **ABSOLUTE MAXIMUM RATINGS** (T_C = 25°C unless otherwise specified)

PARA	METER	SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	700	V
Gate-Source Voltage		V_{GSS}	±20	V
Avalanche Current (Note 2)		I _{AR}	10	Α
Dania Oromant	Continuous	Ι _D	10	Α
Drain Current	Pulsed (Note 2)	I _{DM}	40	Α
Accelerate Francis	Single Pulsed (Note 3)	E _{AS}	250	mJ
Avalanche Energy	Repetitive (Note 2)	E _{AR}	15.6	mJ
Peak Diode Recovery dv/d	It (Note 4)	dv/dt	4.5	V/ns
Power Dissipation		P_D	50	W
Junction Temperature		T_J	+150	°C
Operating Temperature		T _{OPR}	-55 ~ +150	°C
Storage Temperature		T_{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature
- 3. L = 14.2mH, I_{AS} = 10A, V_{DD} = 50V, R_{G} = 25 Ω Starting T_{J} = 25°C
- 4. $I_{SD} \le 9.5A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

■ THERMAL DATA

PARAMETER	SYMBOL	RATING	UNIT	
Junction to Ambient	θ_{JA}	62.5	°C/W	
Junction to Case	θ_{JC}	2.5	°C/W	

10N70Z

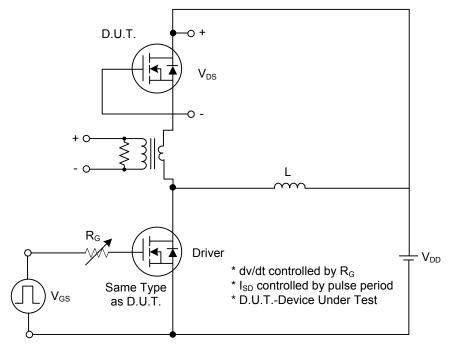
■ ELECTRICAL CHARACTERISTICS(T_C=25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT		
OFF CHARACTERISTICS									
Drain-Source Breakdown Voltage		BV _{DSS}	$V_{GS} = 0V, I_D = 250\mu A$	700			V		
Drain-Source Leakage Current		I _{DSS}	$V_{DS} = 700V, V_{GS} = 0V$			10	μA		
Cata Cauras Laglagas Current	Forward		$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$			5	μA		
Gate-Source Leakage Current	Reverse	I_{GSS}	$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$			-5	μA		
Breakdown Voltage Temperature	reakdown Voltage Temperature Coefficient		I_D = 250 μ A, Referenced to 25°C		0.7		V/°C		
ON CHARACTERISTICS									
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0		4.0	V		
Static Drain-Source On-State Resistance		R _{DS(ON)}	$V_{GS} = 10V, I_D = 5A$		0.9	1.2	Ω		
DYNAMIC CHARACTERISTICS									
Input Capacitance		C _{ISS}			1570	2040	рF		
Output Capacitance Reverse Transfer Capacitance		Coss	V _{DS} =25V, V _{GS} =0V, f=1.0 MHz		166	215	pF		
		C_{RSS}]		18	24	pF		
SWITCHING CHARACTERISTIC	cs	_				=.	-		
Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time		$t_{D(ON)}$			23	55	ns		
		t_R	V_{DS} =350V, I_{D} =10A, R_{G} =25 Ω		69	150	ns		
		t _{D(OFF)}	(Note 1, 2)		144	300	ns		
		t_{F}			90	165	ns		
Total Gate Charge Gate-Source Charge Gate-Drain Charge		Q_{G}	\\ _FCO\\ _404 \\ _404		44	57	nC		
		Q_GS	V _{DS} =560V, I _D =10A, V _{GS} =10 V		6.7		nC		
		Q_GD	(Note 1, 2)		18.5		nC		
DRAIN-SOURCE DIODE CHARA	ACTERISTIC	CS AND MAX	IMUM RATINGS						
Drain-Source Diode Forward Voltage		V_{SD}	$V_{GS} = 0 \text{ V}, I_{S} = 10 \text{A}$			1.4	V		
Maximum Continuous Drain-Source Diode		I _S				10	Α		
Forward Current						10	А		
Maximum Pulsed Drain-Source Diode		lou				40	Α		
Forward Current		I _{SM}				70	^		
Reverse Recovery Time		t _{rr}	$V_{GS} = 0 \text{ V}, I_{S} = 10\text{A},$		420		ns		
Reverse Recovery Charge		Q_{RR}	$dI_F / dt = 100 A/\mu s \text{ (Note 1)}$		4.2		μC		

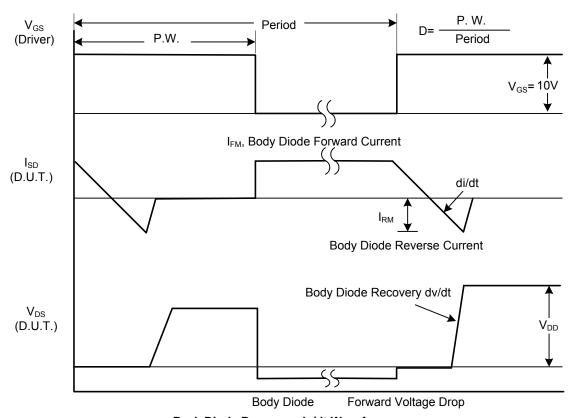
Notes: 1. Pulse Test : Pulse width \leq 300 μ s, Duty cycle \leq 2%

^{2.} Essentially independent of operating temperature

■ TEST CIRCUITS AND WAVEFORMS

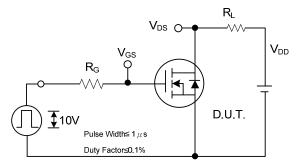


Peak Diode Recovery dv/dt Test Circuit

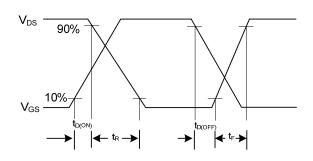


Peak Diode Recovery dv/dt Waveforms

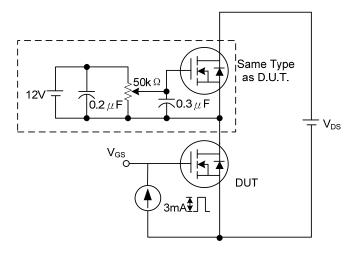
■ TEST CIRCUITS AND WAVEFORMS (Cont.)



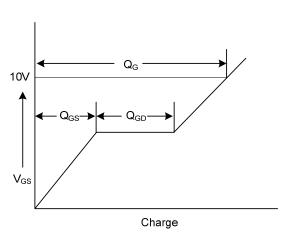
Switching Test Circuit



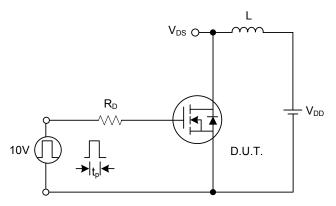
Switching Waveforms



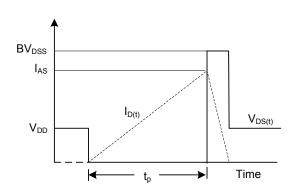
Gate Charge Test Circuit



Gate Charge Waveform

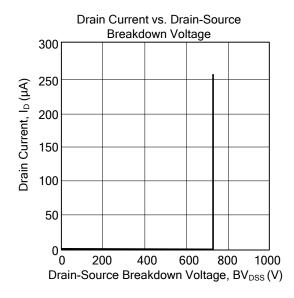


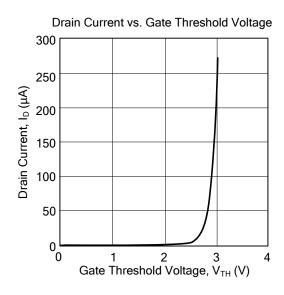
Unclamped Inductive Switching Test Circuit

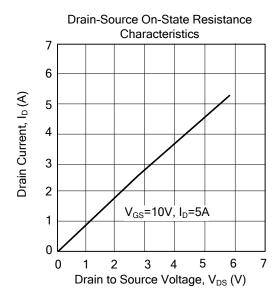


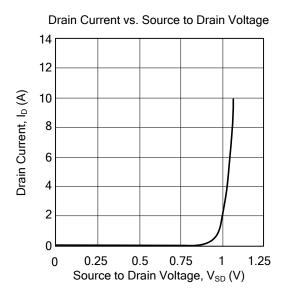
Unclamped Inductive Switching Waveforms

■ TYPICAL CHARACTERISTICS









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